

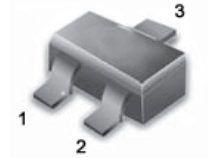


General Purpose Transistors



FEATURE

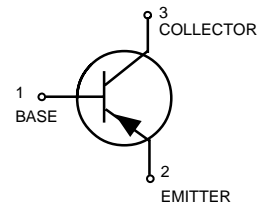
- High Voltage: $V_{CEO} = -50$ V.
- Epitaxial planar type.
- NPN complement: 2SC1623



SOT-23

DEVICE MARKING AND ORDERING INFORMATION

Device	Marking	Shipping
2SA812Q	M8	3000/Tape&Reel
2SA812R	M6	
2SA812S	M7	



MAXIMUM RATINGS

Rating	Symbol	2SA812	Unit
Collector-Emitter Voltage	V_{CEO}	-50	V
Collector-Base Voltage	V_{CBO}	-60	V
Emitter-Base Voltage	V_{EBO}	-6	V
Collector current-continuoun	I_c	-150	mAdc

THERMAL CHARATEERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (1) $T_A=25^\circ\text{C}$	P_D	200	mW
Derate above 25°C		1.8	mW/ $^\circ\text{C}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	556	$^\circ\text{C}/\text{W}$
Total Device Dissipation Alumina Substrate, (2) $T_A=25^\circ\text{C}$	P_D	200	mW
Derate above 25°C		2.4	mW/ $^\circ\text{C}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	417	$^\circ\text{C}/\text{W}$
Junction and Storage Temperature	T_j, T_{stg}	-55 to +150	$^\circ\text{C}$

DEVICE CHARACTERISTICS

2SA812Q/R/S

ELECTRICAL CHARACTERISTICS (TA=25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage (IC=-1mA)	V _{(BR)CEO}	-50	-	-	V
Emitter-Base Breakdown Voltage (IE=-50 μA)	V _{(BR)EBO}	-6	-	-	V
Collector-Base Breakdown Voltage (IC=-50 μA)	V _{(BR)CBO}	-60	-	-	V
Collector Cutoff Current (V _{CB} =-50V)	I _{CBO}	-	-	-0.1	μA
Emitter Cutoff Current (V _{BE} =-6V)	I _{EBO}	-	-	-0.1	μA

ON CHARACTERISTICS

DC Current Gain (IC=-1mA, V _{CE} =-6.0V)	h _{FE}	120	-	560	
Collector-Emitter Saturation Voltage (IC=-100mA, IB=-10mA)	V _{CE(sat)}	-	-0.18	-0.3	V
Base -Emitter On Voltage IE=-1.0mA, V _{CE} =-6.0V)	V _{BE}	-0.58	-0.62	-0.68	V

SMALL-SIGNAL CHARACTERISTICS

Current-Gain-Bandwidth Product (V _{CE} =-6.0V, IE=-10mA)	F _t	-	180	-	MHz
Output Capacitance(V _{CE} = -10V, IE=0, f=1.0MHz)	C _{obo}	-	4.5	-	pF

h_{FE} Values are classified as follows

NOTE:	*	Q	R	S
	h _{FE}	120~270	180~390	270~560

DEVICE CHARACTERISTICS

2SA812Q/R/S

Fig.1 Grounded emitter propagation characteristics

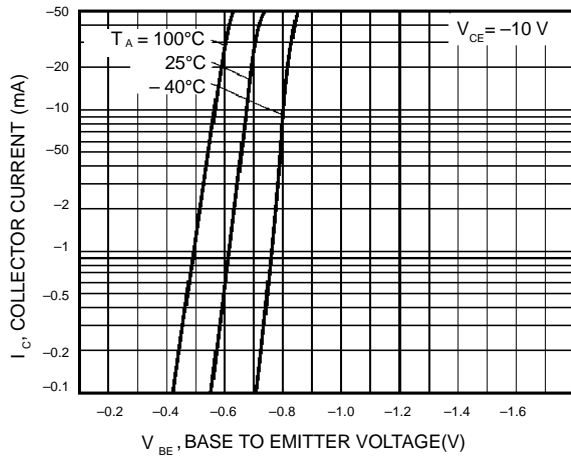


Fig.2 Grounded emitter output characteristics(I)

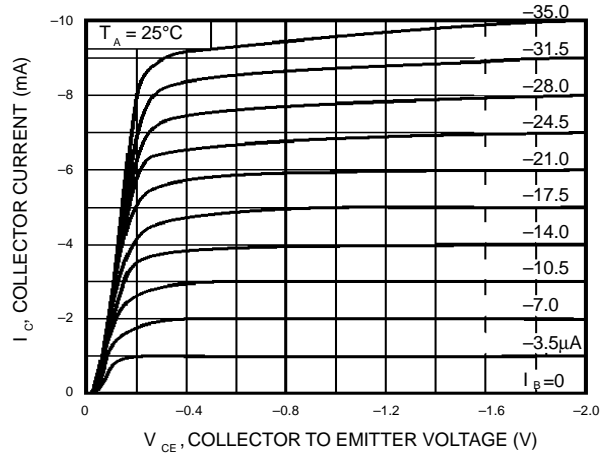


Fig.3 Grounded emitter output characteristics(II)

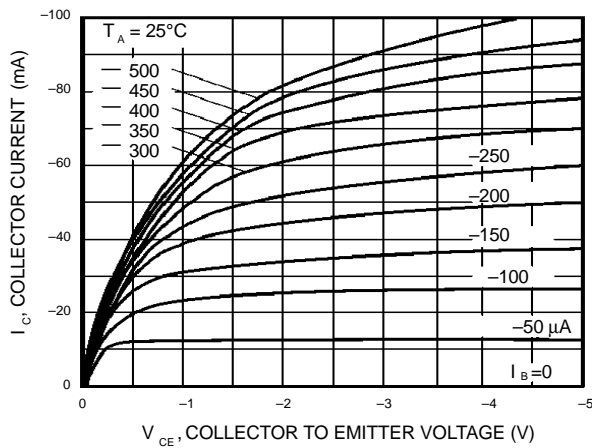


Fig.4 DC current gain vs. collector current (I)

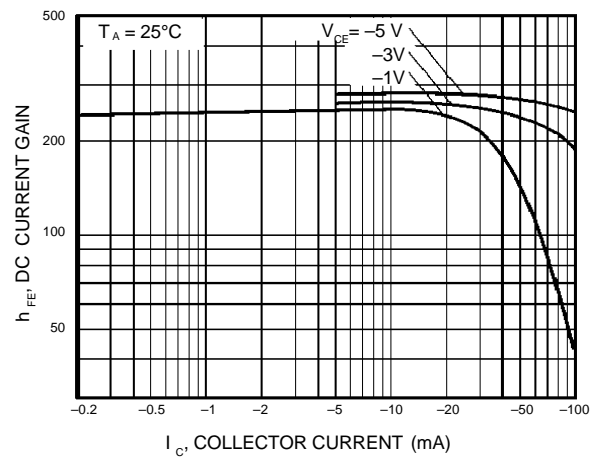


Fig.5 DC current gain vs. collector current (II)

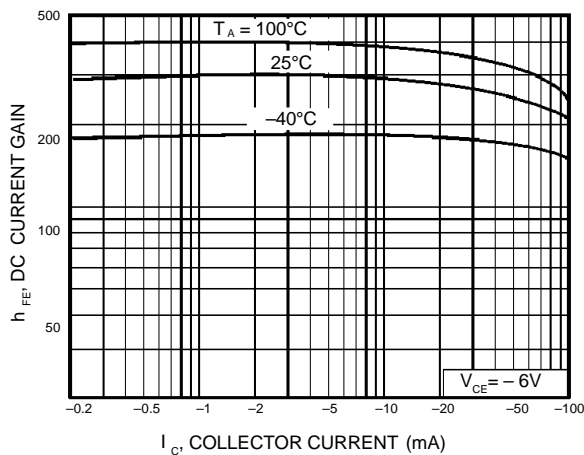
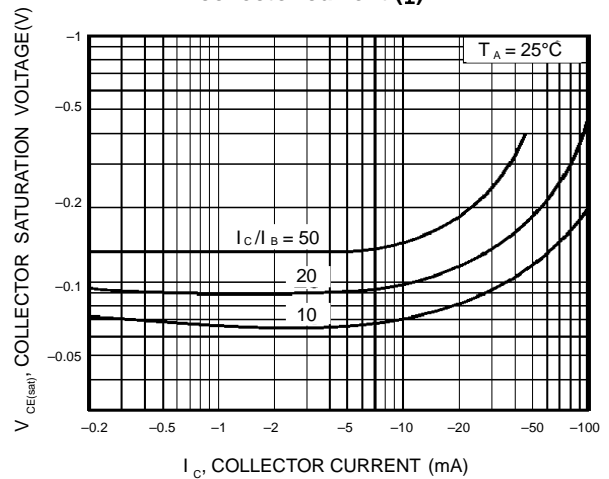


Fig.6 Collector-emitter saturation voltage vs. collector current (I)



PACKAGE OUTLINE & DIMENSIONS

2SA812Q/R/S

Fig.7 Collector-emitter saturation voltage vs. collector current (II)

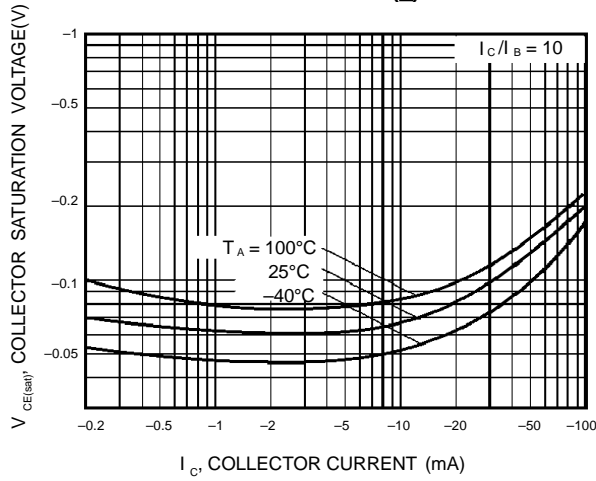
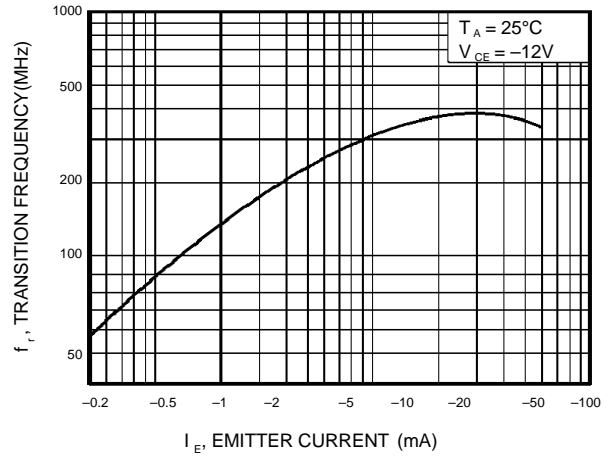
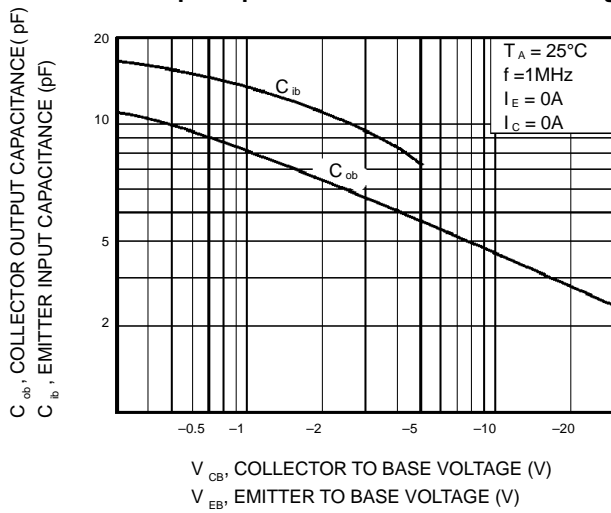


Fig.8 Gain bandwidth product vs. emitter current



**Fig.9 Collector output capacitance vs. collector-base voltage
Emitter input capacitance vs. emitter-base voltage**



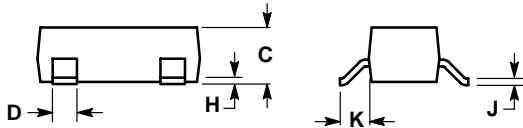
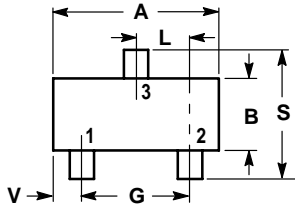
PACKAGE OUTLINE & DIMENSIONS

2SA812Q/R/S

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NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M,1982
2. CONTROLLING DIMENSION: INCH.



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.1102	0.1197	2.80	3.04
B	0.0472	0.0551	1.20	1.40
C	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
H	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0140	0.0285	0.35	0.69
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.1039	2.10	2.64
V	0.0177	0.0236	0.45	0.60

